

# Supplementary Information

## Single-step manufacturing of hierarchical dielectric metalens in the visible

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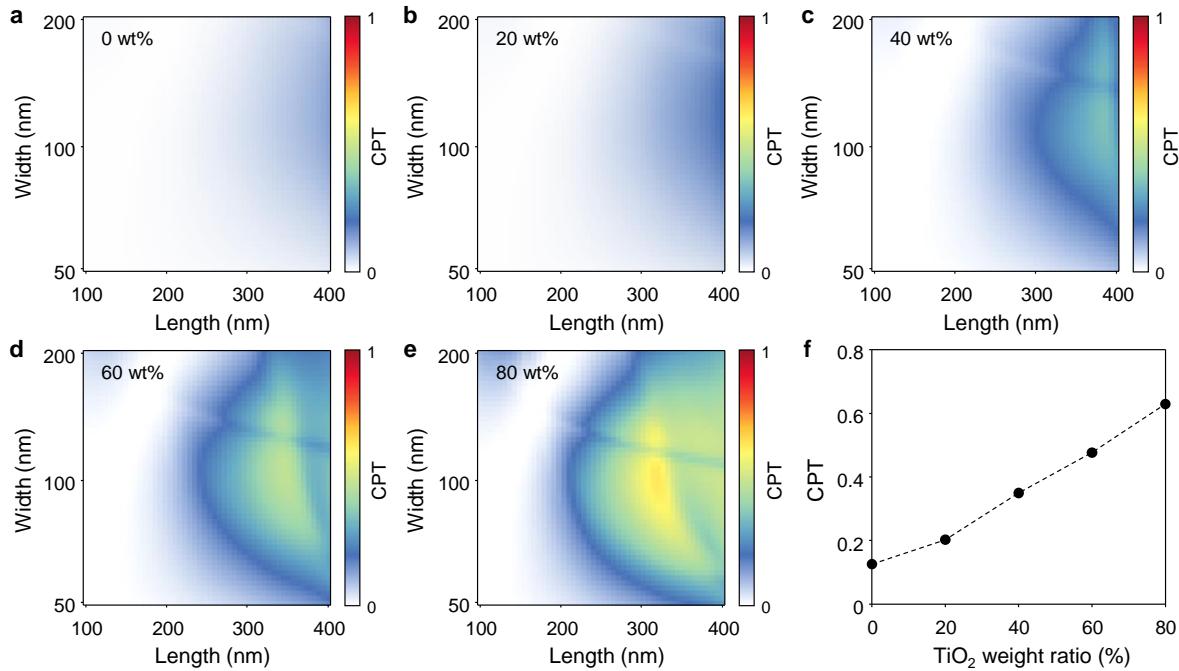
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## Supplementary Figure 1



**Figure 1.** The effect of titanium dioxide ( $\text{TiO}_2$ ) weight ratio on the metalens efficiency at the wavelength of 532 nm. **a-e** Calculated cross-polarization transmittance (CPT) of rectangular nanostructures using measured refractive indices of the nanoparticle composite. Height: 720 nm; pitch: 450 nm. The length varies from 100 nm to 400 nm while the width varies from 50 nm to 200 nm. **f** The maximum CPT variation according to the  $\text{TiO}_2$  weight ratio. The dashed line is to guide the eye.

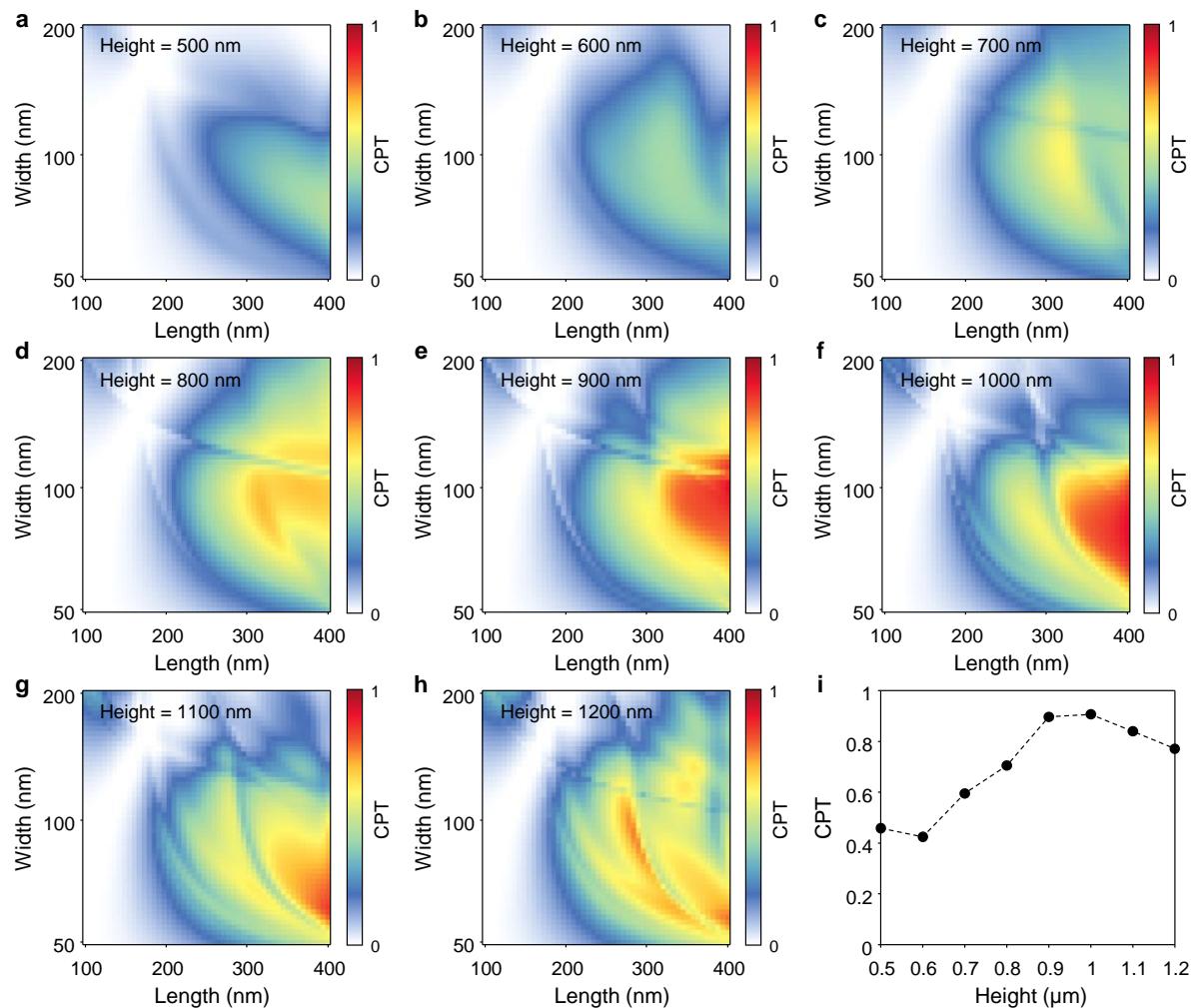
### Supplementary Table 1

**Table 1. Comparison of our method with typical nanoimprint lithography in the fabrication of dielectric metasurfaces**

	Nanoimprint lithography (TiO <sub>2</sub> or GaN)	This work
<b>Thin-film deposition</b>	Necessary	Unnecessary
<b>Thin-film etching</b>	Necessary	Unnecessary
<b>Patterning on flexible substrate</b>	Not easy due to thermal damages from thin film deposition or etching steps	Possible
<b>Optical properties</b>	Controllable but very limited	Widely controllable by the content of nanoparticles
<b>General replication procedure</b>	1. Thin-film deposition on a substrate 2. Dropping the resist on the film 3. UV-NIL with a printing mold 4. Residue layer removal 5. Dry etching of the thin film 6. Resist residue removal	1. Dropping the NPC on a substrate 2. UV-NIL with a printing mold

TiO<sub>2</sub>: titanium dioxide; GaN: gallium nitride; NPC: nanoparticle composite; NIL: nanoimprint lithography.

## Supplementary Figure 2



**Figure 2.** The effect of the structure height on the metalens efficiency at the wavelength of 532 nm. **a-h** Calculated cross-polarization transmittance (CPT) of rectangular nanostructures based on the nanoparticle composite. Pitch: 450 nm. The length varies from 100 nm to 400 nm while the width varies from 50 nm to 200 nm. **i** The maximum CPT variation according to the structure height. The dashed line is to guide the eye.